

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	477977	thin adj film	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:56
L2	2	"20020070382".pn. and (driver adj circuit)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:56
L3	2	"20020070382".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:53
L4	65767	1 same (wiring line)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:47
L5	2	3 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:47
L6	2	"6953951".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:53

L7	61	("20010010370" "20010019374" "20010025959" "20010030322" "20020008797" "20020044230" "20020070382" "20020110941" "20020127833" "20020158288" "20030038037" "20030132436" "20040197971" "20040217357" "20050040403" "4033833" "5498573" "5576858" "5643826" "5650636" "5712495" "5726461" "5756147" "5777701" "5815226" "5851918" "5856689" "5889291" "5892562" "5923962" "5929948" "5977562" "5990998" "5990999" "5998841" "6015724" "6031290" "6104461" "6114715" "6118506" "6137218" "6175395" "6208395" "6274887" "6278131" "6281552" "6303963" "6306694" "6319741" "6323515" "6359320" "6384818" "6392255" "6413845" "6461899" "6469317" "6489222" "6500701" "6509616" "6524877" "6737304").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/07 08:56
L8	953114	oled led (light adj emitting)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:56
L9	14977	1 same 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:56
L10	28580	8 same ((integrated driv\$3) adj circuit)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:30
L11	898	4 and 9 and 10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:57

L12	82	printer and 11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:11
L13	6	("6696704" "6614056").pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:11
L14	57947	substrate near4 ((integrated driv\$3) adj circuit)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:31
L15	3	(14 near4 embedded) with bonded	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:31
L16	8	(14 with embedded) same bonded	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:32
L17	15	(14 with embedded) and (14 with bonded)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:33
L18	8	17 not 16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:32
L19	23	11 and (14 with bonded)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:53

L20	1682	347/237-238,247.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:54
L21	5425	257/72,75,84,93,359,528,532.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:54
L22	7106	20 21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:54
L23	1082	22 and 14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:56
L24	531	22 and (((thin adj conductive adj film) (thin adj2 film)) near2 (connect\$3 wir\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:56
L25	159	23 and 24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:58
L26	23	22 and (bonded near4 14)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:56
L27	0	25 and 26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:56

S1	477977	thin adj film	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:43
S2	67885	S1 with semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:12
S3	53015	S1 with ((integrated adj circuit) (driv\$3 circuit))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:19
S4	20570	S1 with (connection wiring)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:12
S5	3013	S2 and S3 and S4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 17:43
S6	1115	S2 same S3 same S4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 17:43
S7	587	S2 same S3 same S4 same substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 17:53
S8	219763	conductive near2 layer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 17:43

S9	28	S7 same S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 17:43
S10	426	S7 and @ay<="2002"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:12
S11	426	S10 and S2 and S3 and S4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 17:57
S12	35204	S1 near3 semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:12
S13	22663	S1 near3 ((integrated adj circuit) (driv\$3 circuit))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:12
S14	7547	S1 near3 (connection wiring)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:12
S15	402	S12 and S13 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:19
S16	275	S15 and @ay<="2002"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:20

S17	7739	led adj2 print\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:17
S18	1	S16 and S17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:17
S19	11370	S1 with ((integrated adj circuit))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:19
S20	215	S12 and S19 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:19
S21	153	S20 and @ay<="2002"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:22
S22	318661	light adj emitting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:22
S23	24	S21 and S22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:23
S24	14303	S12 with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:24

S25	6698	S13 with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:24
S26	1146	S24 and S25	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:24
S27	130	S24 and S25 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:41
S28	6	("5681756" "5963287" "6242358"). pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/06 18:42
S29	10	("5681756").URPN.	USPAT	OR	ON	2005/12/06 18:50
S30	9	("5142343" "5457565" "5640067" "5677572" "5681756" "5739545" "5970318" "6150668" "6303239").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/06 18:51
S31	7	("5349205" "5384517" "5640067" "5663573" "5705826" "5853905" "5876786").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/06 18:59
S32	18	("3943547" "4492974" "4641171" "4672407" "4680604" "4689647" "4694313" "4760431" "4761679" "4782372" "4878957" "4879584" "4881120" "4914496" "4928155" "4963951" "5040043" "Re32784").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/06 19:09
S33	11	("4345248" "4644338" "4782340" "4810059" "4923285" "5107355" "5206749" "5339090" "5347154" "5471225" "5534722").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/06 19:14